Electronic Patent Application Fee Transmittal							
Application Number:	10540866						
Filing Date:	27-Jun-2005						
Title of Invention:	Expandable resin beads of styrene-modified straight-chain and low-density polyethylenne, process the production thereof, pre-expanded beads, and foams						
First Named Inventor/Applicant Name:	Hideyasu Matsumura						
Filer:	Heribert Muensterer/Liping Qi						
Attorney Docket Number:	P28094						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Request for oral hearing		1403	1	1080	1080		
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:	_						

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			1080